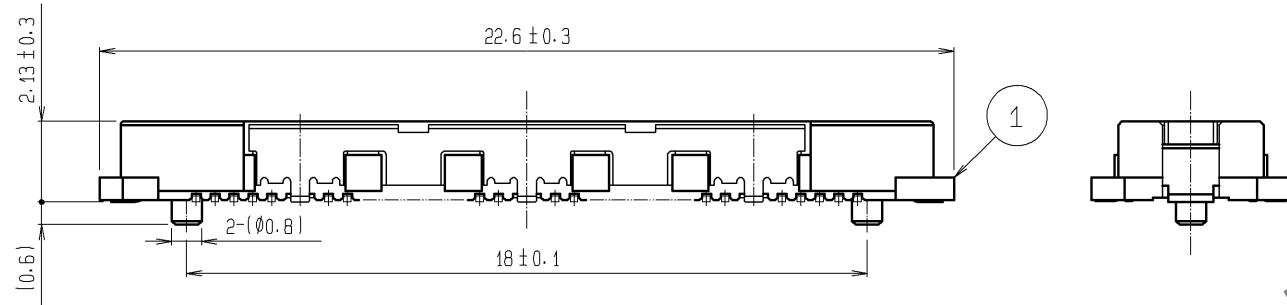
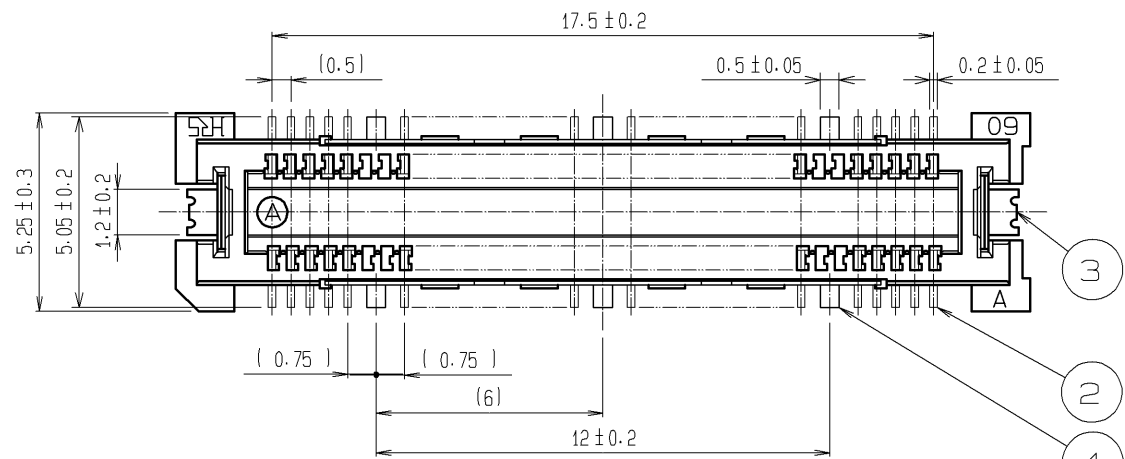
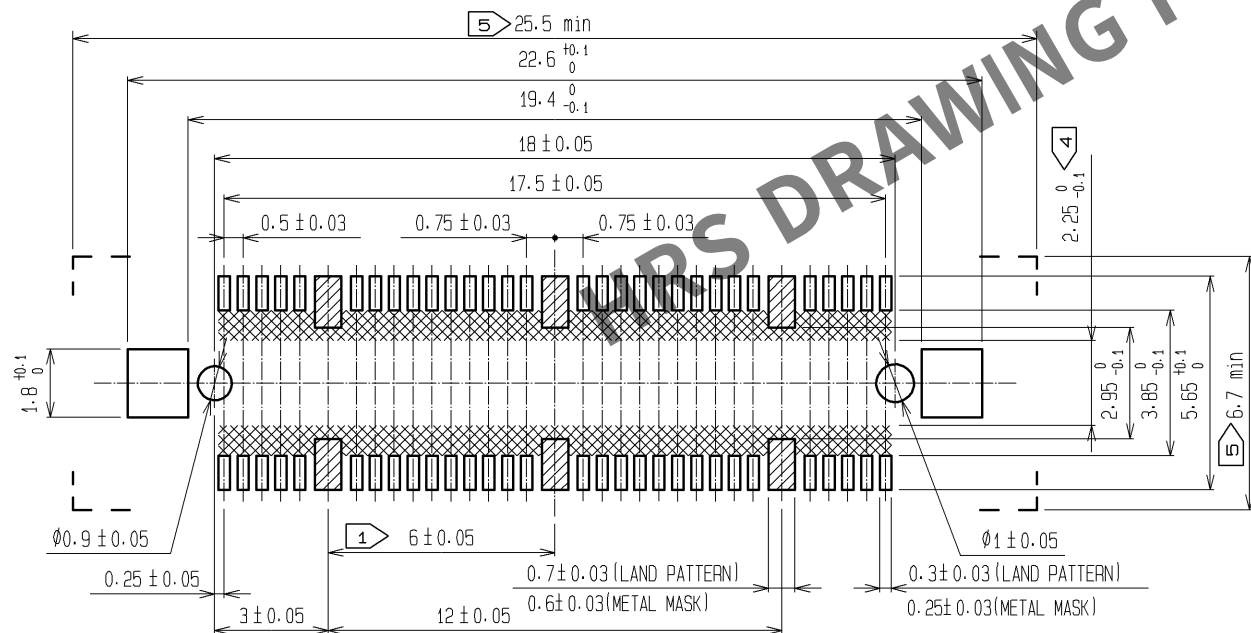
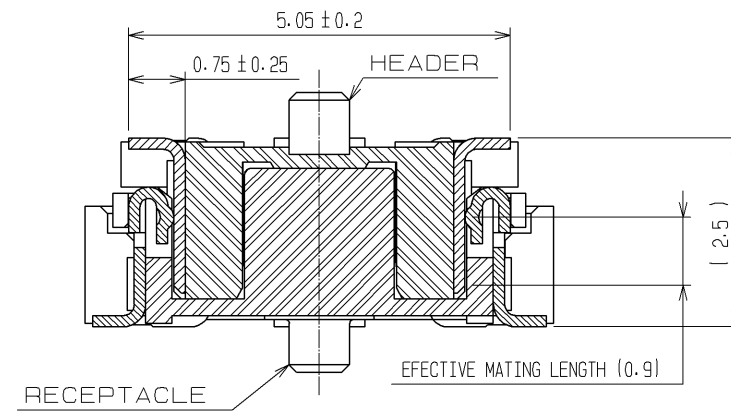
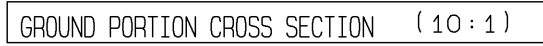
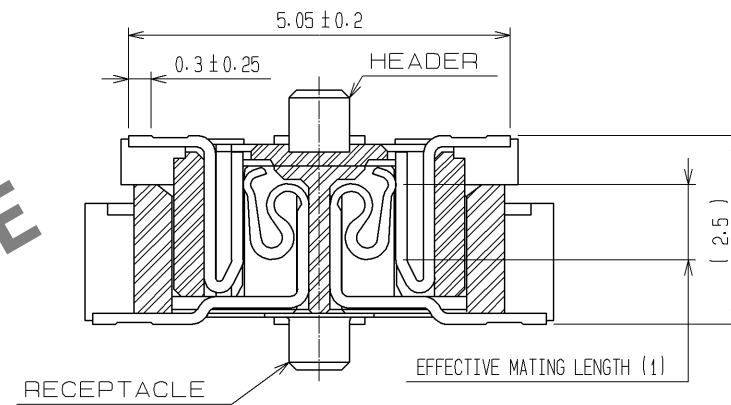




RECOMMENDED LAND PATTERN DIMENSION OF PCB



- NOTES
- 1 6 HATCHED  PARTS: GROUND CIRCUIT.
 - 2 SMT LEAD-COPLANARITY: 0.1 MAX.
 - 3 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - 4 MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED  AREA.)
 - 5 DO NOT MOUNT OTHER DEVICES ONTO  AREA, OR MATING PAIR CANNOT BE MATED.
 - 6 TO BE EMBOSSED CARRIER TAPED AS SPECIFIED IN SHEET 2.
 - 7 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.



3. 4			PHOSPHOR BRONZE	TIN PLATING	2	COPPER ALLOY	CONTACT AREA : GOLD 0.1μm min.			
1			LCP	BEIGE UL94V-0			LEAD AREA : GOLD FLASH			
NO.			MATERIAL	FINISH , REMARKS			UNDER PLATING : NICKEL 1μm min.			
UNITS mm				SCALE 5 : 1		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.					APPROVED : HS. OKAWA		07. 06. 22	DRAWING NO. EDC3-152597-22		
					CHECKED : HS. OZAWA		07. 06. 22	PART NO. FX11A-60P/6-SV(92)		
					DESIGNED : KT. DOI		07. 06. 21	CODE NO. CL573-0502-0-92		
					DRAWN : TS. MIYAKI		07. 06. 19	 1		

